# **RF Devices and RF Circuit Design** for Digital Communication

### Agenda • Fundamentals of RF Circuits • Transmission Line Reflection Coefficient & Smith Chart • Impedance Matching • S-matrix Representation

- Amplifiers & Unilateral Gain
- RF Devices
- Digital RF

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- Basic distributed element: Transmission Line F-matrix of Transmission Line  $F = \begin{bmatrix} \cos\theta & jZ_0 \sin\theta \\ j\sin\theta/Z_0 & \cos\theta \end{bmatrix}$  $Z_0$ : Characteristic impedance of Transmission Line  $\theta$ : Phase delay  $\left(=\beta\ell=\omega\sqrt{\varepsilon\mu}\ell=\omega\ell/\nu\right)$  $\ell$ : length v: velocity 2010/07/02 Wireless Communication Engineering





















• Voltage Standing Wave Ratio (VSWR) $\geq 1$   $VSWR = \frac{V_{max}}{V_{min}} = \frac{V_i + V_r}{V_i - V_r}$   $|\Gamma| = \frac{V_r}{V_i} = \frac{VSWR - 1}{VSWR + 1}$   $V_i$ : incident wave  $V_r$ : reflected wave • Special Terminations / Circuits  $-Matched load: (Z_L = Z_0) \rightarrow \Gamma = 0$ , No reflection - Smith-chart and its usage • Smith-chart (Bell Lab. 1950's)  $Z_{in} = Z_0 \frac{Z_L + jZ_0 \tan \theta}{Z_0 + jZ_L \tan \theta}$   $\overline{Z_L \rightarrow \widetilde{Z}_L} = \frac{Z_L}{Z_0} \rightarrow \Gamma_L = \frac{\widetilde{Z}_L - 1}{\widetilde{Z}_L + 1} \rightarrow$   $\Gamma_{in} = \Gamma_L \exp^{-j2\theta} \rightarrow \widetilde{Z}_{in} = \frac{1 + \Gamma_{in}}{1 - \Gamma_{in}} \rightarrow Z_{in}$ Wireless Communication Engineering 1

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SVD (Singular Value Decomposition)  $S=U^{\dagger}DV$  (Youla) U,V: Unitary matrix (Lossless Circuit) D: Diagonal Matrix ( $\rightarrow$  Isolated *n*-port circuit)  $D = Diag[\lambda_1, ..., \lambda_n]$   $\lambda_i < 1 \rightarrow resistance$   $\lambda_i > 1 \rightarrow negative resistance$ (2010/07/02)







Unilateral Transducer Gain  $G_{TU}$ (For the case,  $S_{12} = 0$  Reverse transfer coefficient from output to input)  $FET S - parameter \begin{vmatrix} S_{11} & S_{12} \\ S_{21} & S_{22} \end{vmatrix}$  $G_{TU} = \frac{(1 - |\Gamma_s|^2)}{|1 - S_{11}\Gamma_s|^2} \cdot |S_{21}|^2 \cdot \frac{(1 - |\Gamma_L|^2)}{|1 - S_{22}\Gamma_L|^2}$  $= G_s \cdot G_0 \cdot G_L$  $G_{TU,max} = \frac{1}{1 - |S_{11}|^2} \cdot |S_{21}|^2 \cdot \frac{1}{1 - |S_{22}|^2}$ Wireless Communication Engineering 1







2-state device

- On-state impedance Z1, Off-state impedance Z2
- $M=|Z1-Z2|/|Z1+Z2^*| \Rightarrow$  Invariant w.r.t. Lossless 2port connection
- M= $|\Gamma 1-\Gamma 2| / |1-\Gamma 1\Gamma 2^*| \Rightarrow$  Optimum BPSK Direct Modulation Design



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# Digital RF Circuits

- RF-CMOS Technology
- Analog Signal Processing & Digital Signal Processing
- Continuous Time & Discrete Time
- Direct Conversion & Sampling
- Built-in RF Self Test & Calibration



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### **DRP/SoC Proven Across Many Products**

























